

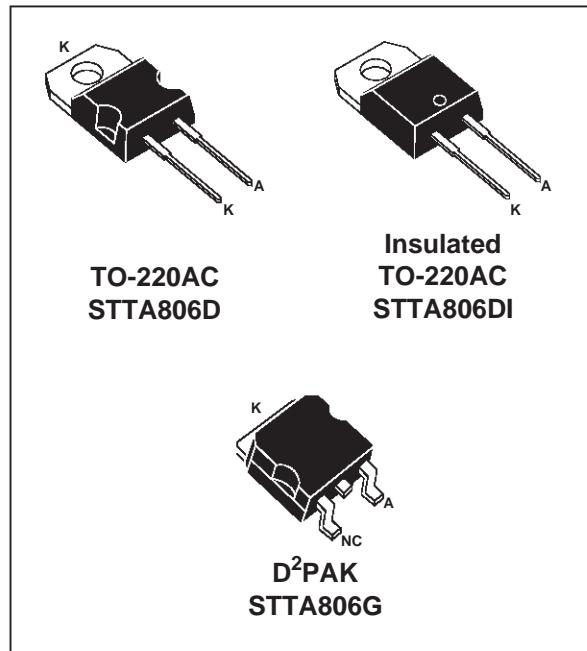
## TURBOSWITCH ULTRA-FAST HIGH VOLTAGE DIODE

### MAIN PRODUCTS CHARACTERISTICS

$I_{F(AV)}$	8A
$V_{RRM}$	600V
$t_{rr}$ (typ)	25ns
$V_F$ (max)	1.5V

### FEATURES AND BENEFITS

- SPECIFIC TO "FREEWHEEL MODE" OPERATIONS: FREEWHEEL OR BOOSTER DIODE
- ULTRA-FAST AND SOFT RECOVERY
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR
- HIGH FREQUENCY OPERATIONS
- INSULATED PACKAGE : TO-220AC  
Electrical insulation : 2500V<sub>RMS</sub>  
Capacitance < 7 pF



### DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes from 600V to 1200V.

TURBOSWITCH family, drastically cuts losses in both the diode and the associated switching IGBT or MOSFET in all "freewheel mode" operations and is particularly suitable and efficient in motor

control freewheel applications and in booster diode applications in power factor control circuitries.

Packaged either in TO-220AC, insulated TO-220AC or in D<sup>2</sup>PAK, these 600V devices are particularly intended for use on 240V domestic mains.

### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	600	V
$V_{RSM}$	Non repetitive peak reverse voltage	600	V
$I_{F(RMS)}$	RMS forward current	TO-220AC / D <sup>2</sup> PAK	A
		TO-220AC ins.	A
$I_{FRM}$	Repetitive peak forward current	tp=5ms F=5kHz square	A
$I_{FSM}$	Surge non repetitive forward current	tp=10 ms sinusoidal	A
$T_j$	Maximum operating junction temperature	150	°C
$T_{stg}$	Storage temperature range	-65 to 150	°C

TM : TURBOSWITCH is a trademark of STMicroelectronics

## STTA806D/DI/G

### THERMAL AND POWER DATA

Symbol	Parameter		Conditions	Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	TO-220AC / D <sup>2</sup> PAK TO-220AC ins.		2.2 3.3	°C/W
$P_1$	Conduction power dissipation $I_{F(AV)} = 8A \quad \delta = 0.5$	TO-220AC / D <sup>2</sup> PAK TO-220AC ins.	$T_c = 118^\circ C$ $T_c = 102^\circ C$	14.5	W
$P_{max}$	Total power dissipation $P_{max} = P_1 + P_3$ ( $P_3 = 10\% P_1$ )	TO-220AC / D <sup>2</sup> PAK TO-220AC ins.	$T_c = 115^\circ C$ $T_c = 97^\circ C$	16	W

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions		Min	Typ	Max	Unit
$V_F$ *	Forward voltage drop	$I_F = 8A$	$T_j = 25^\circ C$ $T_j = 125^\circ C$		1.25	1.75 1.5	V V
$I_R$ **	Reverse leakage current	$V_R = 0.8 \times V_{RRM}$	$T_j = 25^\circ C$ $T_j = 125^\circ C$		1.5	100 4	µA mA
$V_{to}$	Threshold voltage	$I_p < 3.I_{AV}$	$T_j = 125^\circ C$			1.15	V
$r_d$	Dynamic resistance					43	mΩ

Test pulse : \*  $t_p = 380 \mu s, \delta < 2\%$

\*\*  $t_p = 5 ms, \delta < 2\%$

To evaluate the maximum conduction losses use the following equation :  
 $P = V_{to} \times I_{F(AV)} + r_d \times I_F^2(RMS)$

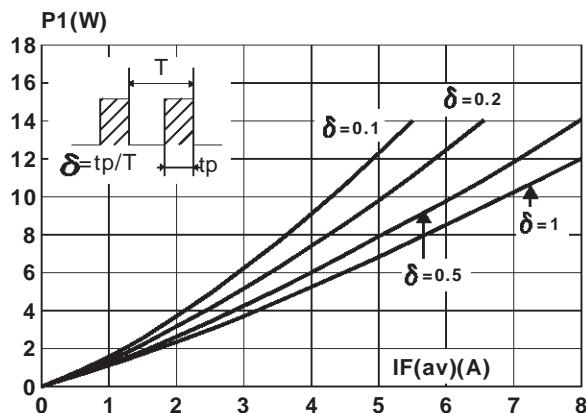
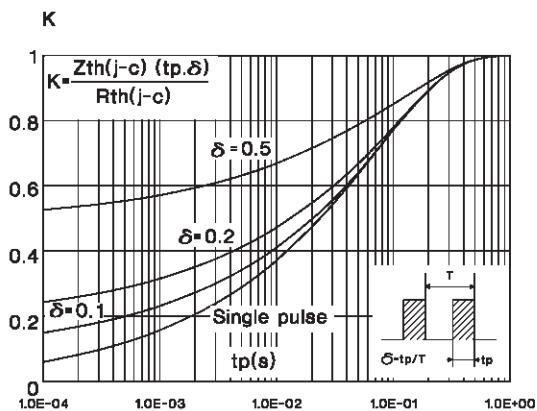
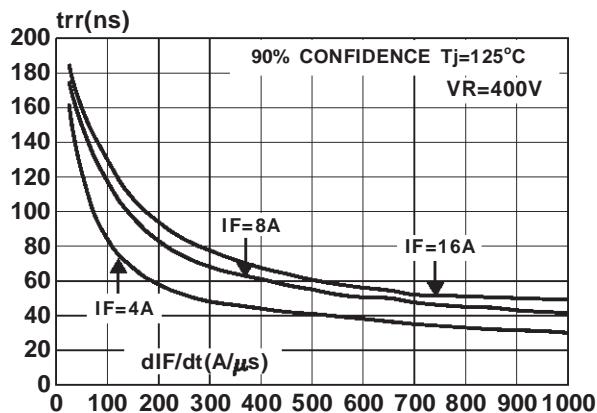
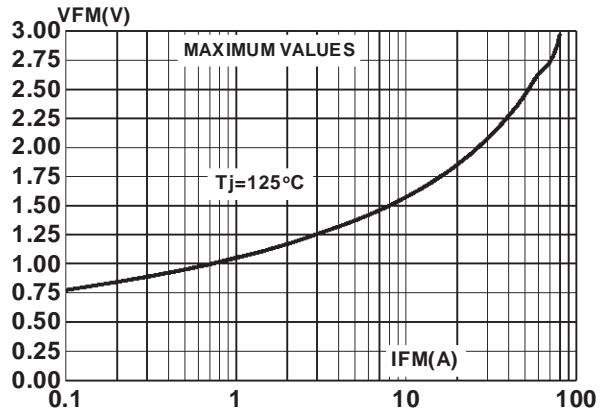
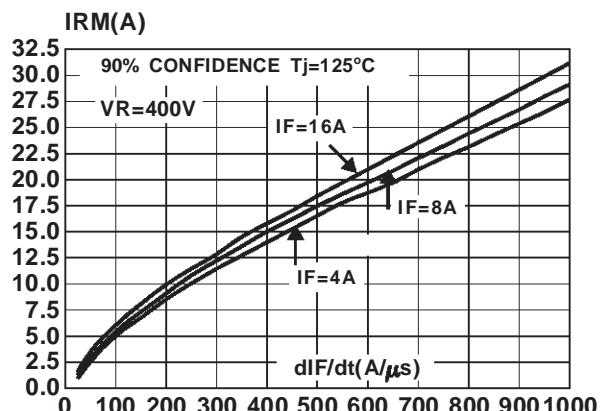
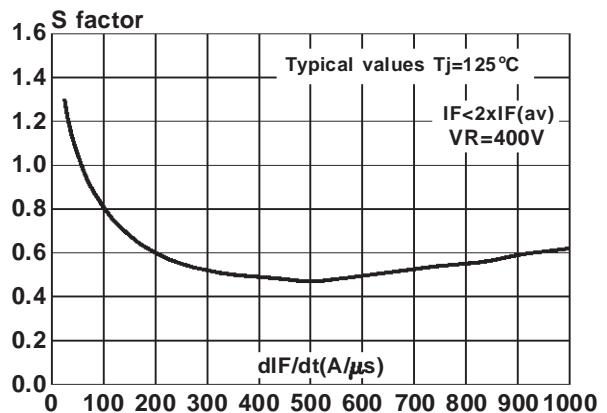
### DYNAMIC ELECTRICAL CHARACTERISTICS

#### TURN-OFF SWITCHING

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{rr}$	Reverse recovery time	$T_j = 25^\circ C$ $I_F = 0.5 A \quad I_R = 1A \quad Irr = 0.25A$ $I_F = 1 A \quad dI_F/dt = -50A/\mu s \quad V_R = 30V$		25	52	ns
$I_{RM}$	Maximum reverse recovery current	$T_j = 125^\circ C \quad VR = 400V \quad I_F = 8A$ $dI_F/dt = -64 A/\mu s$ $dI_F/dt = -500 A/\mu s$		14	5.5	A
S factor	Softness factor	$T_j = 125^\circ C \quad V_R = 400V \quad I_F = 8A$ $dI_F/dt = -500 A/\mu s$		0.47		-

#### TURN-ON SWITCHING

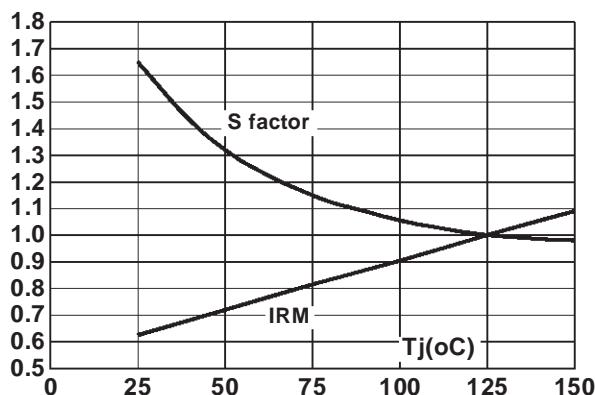
Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{fr}$	Forward recovery time	$T_j = 25^\circ C$ $I_F = 8 A, dI_F/dt = 64 A/\mu s$ measured at, $1.1 \times V_{Fmax}$			500	ns
$V_{Fp}$	Peak forward voltage	$T_j = 25^\circ C$ $I_F = 8A, dI_F/dt = 64 A/\mu s$			10	V

**Fig. 1:** Conduction losses versus average current.**Fig. 3:** Relative variation of thermal transient impedance junction to case versus pulse duration.**Fig. 5:** Reverse recovery time versus  $dI_F/dt$ .**Fig. 2:** Forward voltage drop versus forward current.**Fig. 4:** Peak reverse recovery current versus  $dI_F/dt$ .**Fig. 6:** Softness factor ( $tb/ta$ ) versus  $dI_F/dt$ .

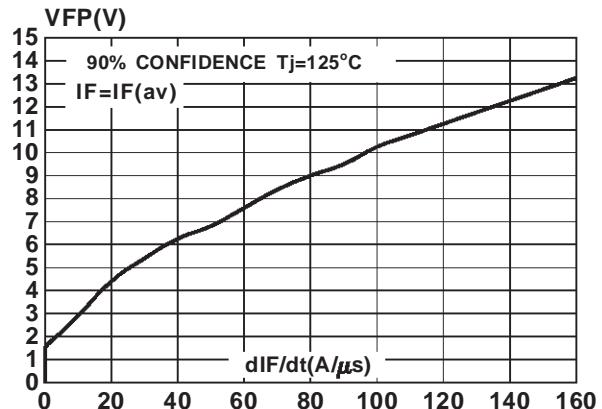
## STTA806D/DI/G

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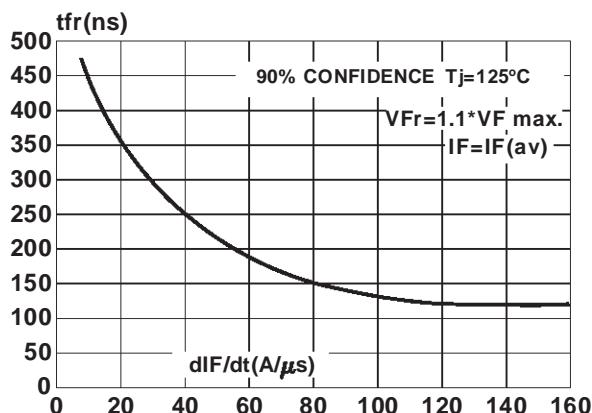
**Fig. 7:** Relative variation of dynamic parameters versus junction temperature (reference  $T_j=125^\circ\text{C}$ ).



**Fig. 8:** Transient peak forward voltage versus  $dI_F/dt$ .



**Fig. 9:** Forward recovery time versus  $dI_F/dt$ .



## APPLICATION DATA

The TURBOSWITCH is especially designed to provide the lowest overall power losses in any "FREEWHEEL Mode" application (Fig.A) considering both the diode and the companion

transistor, thus optimizing the overall performance in the end application.  
The way of calculating the power losses is given below:

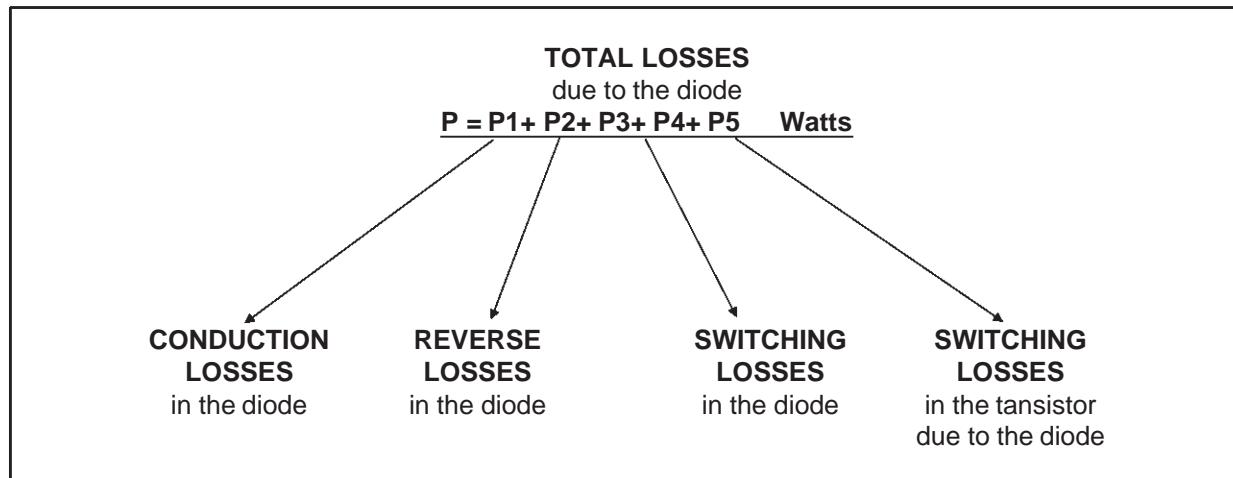
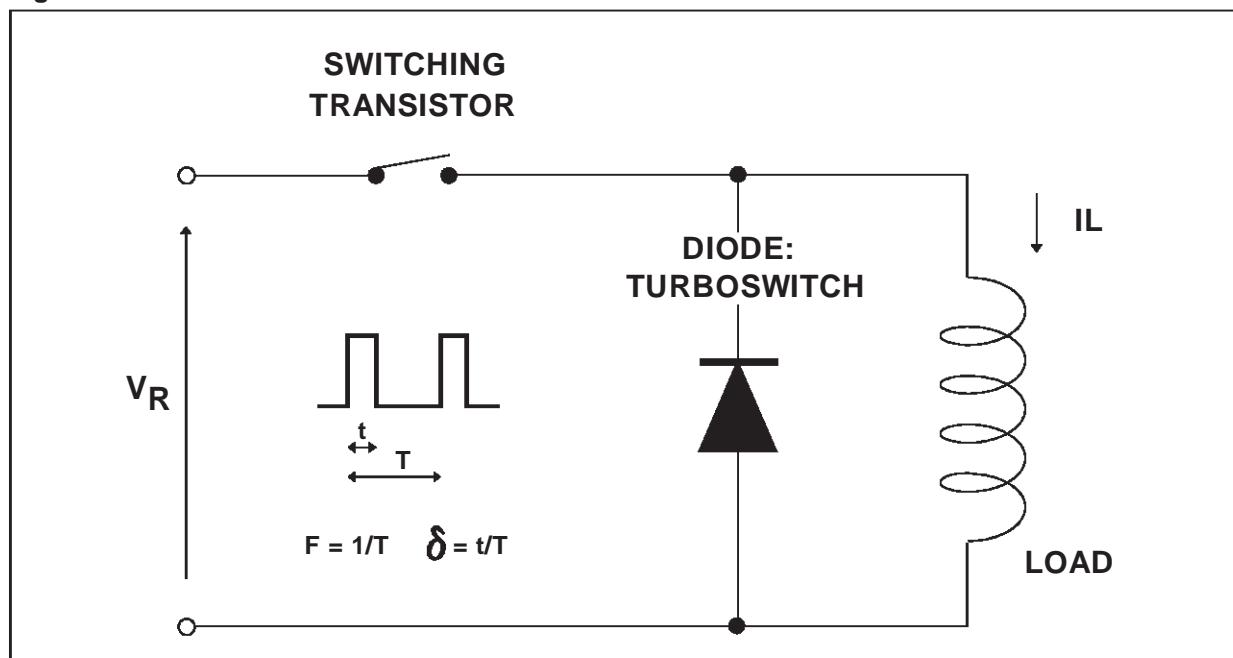
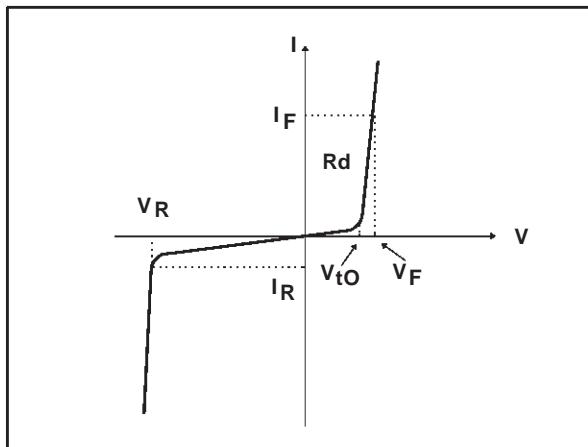


Fig. A : "FREEWHEEL" MODE.



**APPLICATION DATA (Cont'd)**

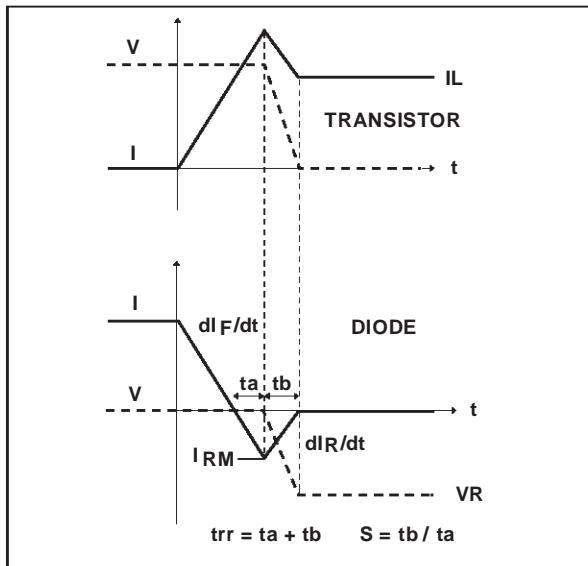
**Fig. B: STATIC CHARACTERISTICS**



**Conduction losses :**

$$P1 = V_{t0} \cdot I_F(\text{AV}) + R_d \cdot I_F^2(\text{RMS})$$

**Fig. C: TURN-OFF CHARACTERISTICS**



**Turn-on losses :**

(in the transistor, due to the diode)

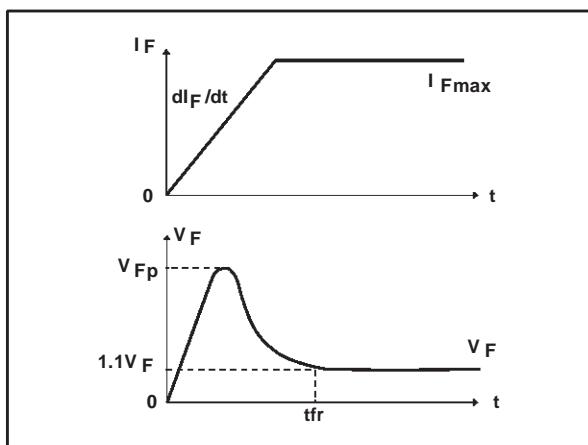
$$P5 = \frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F/dt}$$

**Turn-off losses (in the diode) :**

$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

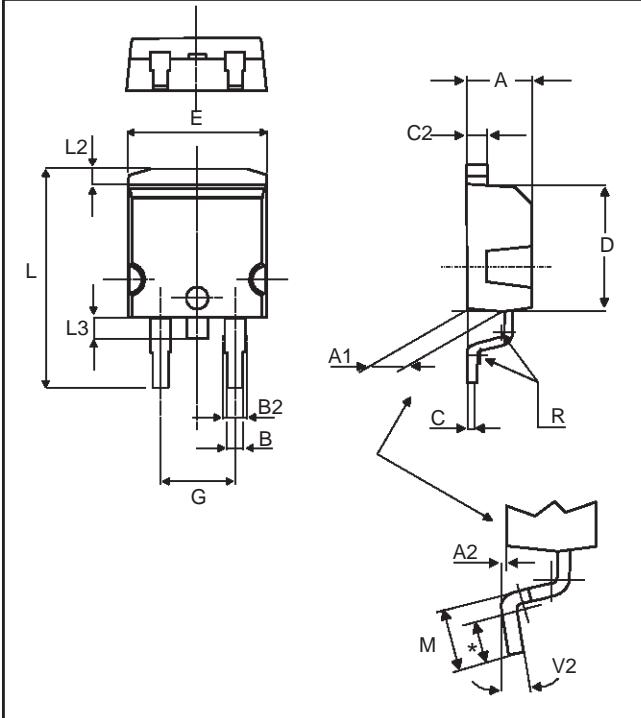
P3 and P5 are suitable for power MOSFET and IGBT

**Fig. D: TURN-ON CHARACTERISTICS**



**Turn-on losses :**

$$P4 = 0.4 (V_{FP} - V_F) \cdot I_{Fmax} \cdot t_{fr} \cdot F$$

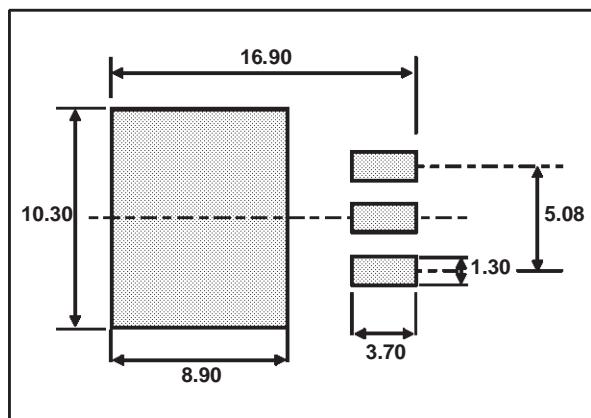
**PACKAGE DATA**  
**D<sup>2</sup>PAK**


\* FLAT ZONE NO LESS THAN 2mm

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
A1	2.49	2.69	0.098	0.106
A2	0.03	0.23	0.001	0.009
B	0.70	0.93	0.027	0.037
B2	1.14	1.70	0.045	0.067
C	0.45	0.60	0.017	0.024
C2	1.23	1.36	0.048	0.054
D	8.95	9.35	0.352	0.368
E	10.00	10.40	0.393	0.409
G	4.88	5.28	0.192	0.208
L	15.00	15.85	0.590	0.624
L2	1.27	1.40	0.050	0.055
L3	1.40	1.75	0.055	0.069
M	2.40	3.20	0.094	0.126
R	0.40 typ.		0.016 typ.	
V2	0°	8°	0°	8°

**FOOTPRINT DIMENSIONS** (in millimeters)

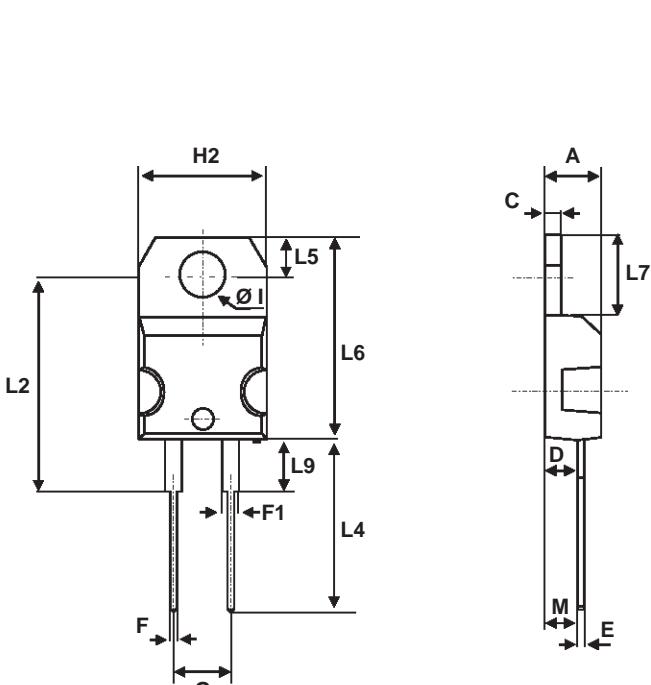
▪ Cooling method : by conduction (C)



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### PACKAGE DATA

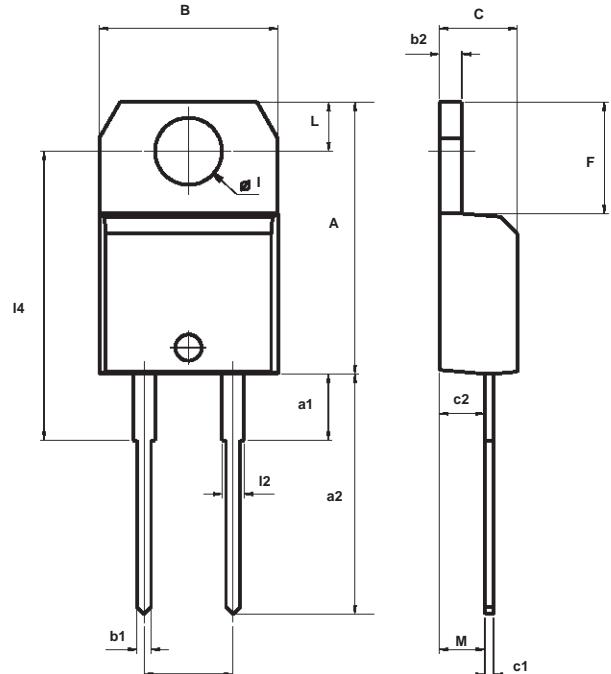
TO-220AC (JEDEC OUTLINE)



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
H2	10.00	10.40	0.393	0.409
L2	16.40 typ.		0.645 typ.	
L4	13.00	14.00	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam. I	3.75	3.85	0.147	0.151

- Cooling method : by conduction (C)
- Recommended torque value : 0.55m.N
- Maximum torque value : 0.7m.N

**PACKAGE DATA**  
INSULATED TO-220AC



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	4.80		5.40	0.189		0.212
F	6.20		6.60	0.244		0.259
I	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
M		2.60			0.102	

- Cooling method : by conduction (C)
- Recommended torque value : 0.8m.N
- Maximum torque value : 1m.N

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTA806D	STTA806D	TO-220AC	1.86g	50	Tube
STTA806DI	STTA806DI	TO-220AC Ins.	1.86g	250	Bulk
STTA806G	STTA806G	D <sup>2</sup> PAK	1.48g	50	Tube
STTA806G-TR	STTA806G	D <sup>2</sup> PAK	1.48g	500	Tape & reel

- Epoxy meets UL94,V0

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